

54F/74F676 16-Bit Serial/Parallel-In, Serial-Out Shift Register

General Description

The 'F676 contains 16 flip-flops with provision for synchronous parallel or serial entry and serial output. When the Mode (M) input is HIGH, information present on the parallel data (P_0 – P_{15}) inputs is entered on the falling edge of the Clock Pulse ($\overline{CP}$) input signal. When M is LOW, data is shifted out of the most significant bit position while information present on the Serial (SI) input shifts into the least significant bit position. A HIGH signal on the Chip Select ($\overline{CS}$) input prevents both parallel and serial operations.

Features

- 16-bit parallel-to-serial conversion
- 16-bit serial-in, serial-out
- Chip select control
- Slim 24 lead 300 mil package

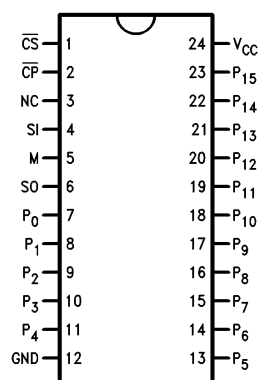
Commercial	Military	Package Number	Package Description
74F676PC		N24A	24-Lead (0.600" Wide) Molded Dual-In-Line
74F676SPC		N24C	24-Lead (0.300" Wide) Molded Dual-In-Line
	54F676DM (Note 2)	J24A	24-Lead (0.600" Wide) Ceramic Dual-In-Line
	54F676SDM (Note 2)	J24F	24-Lead (0.300" Wide) Ceramic Dual-In-Line
74F676SC (Note 1)		M24B	24-Lead (0.300" Wide) Molded Small Outline, JEDEC
	54F676FM (Note 2)	W24C	24-Lead Cerpack
	54F676LM (Note 2)	E28A	24-Lead Ceramic Leadless Chip Carrier, Type C

Note 1: Devices also available in 13" reel. Use suffix = SCX.

Note 2: Military grade device with environmental and burn-in processing. Use suffix = DMQB, FMQB and LMQB.

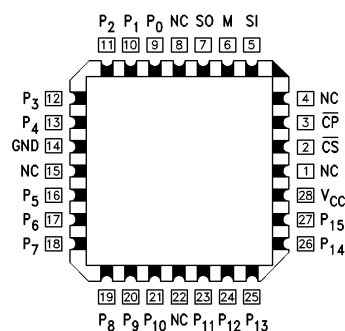
Connection Diagrams

**Pin Assignment
for DIP, SOIC and Flatpak**



TL/F/9588-2

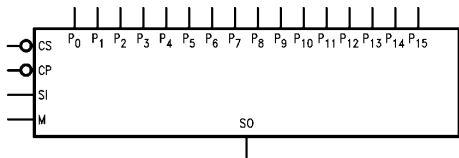
**Pin Assignment
for LCC**



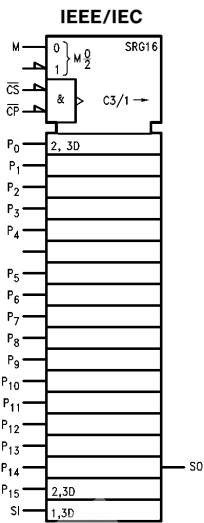
TL/F/9588-3

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Logic Symbols



TL/F/9588-1



TL/F/9588-4

Unit Loading/Fan Out

Pin Names	Description	54F/74F	
		U.L. HIGH/LOW	Input I_{IH}/I_{IL} Output I_{OH}/I_{OL}
P ₀ –P ₁₅	Parallel Data Inputs	1.0/1.0	20 μ A/ –0.6 mA
$\overline{CS}$	Chip Select Input (Active LOW)	1.0/1.0	20 μ A/ –0.6 mA
$\overline{CP}$	Clock Pulse Input (Active LOW)	1.0/1.0	20 μ A/ –0.6 mA
M	Mode Select Input	1.0/1.0	20 μ A/ –0.6 mA
SI	Serial Data Input	1.0/1.0	20 μ A/ –0.6 mA
SO	Serial Output	50/33.3	–1 mA/20 mA

Functional Description

The 16-bit shift register operates in one of three modes, as indicated in the Shift Register Operations Table.

HOLD—a HIGH signal on the Chip Select ($\overline{CS}$) input prevents clocking, and data is stored in the sixteen registers.

Shift/Serial Load—data present on the SI pin shifts into the register on the falling edge of $\overline{CP}$. Data enters the Q₀ position and shifts toward Q₁₅ on successive clocks, finally appearing on the SO pin.

Parallel Load—data present on P₀–P₁₅ are entered into the register on the falling edge of $\overline{CP}$. The SO output represents the Q₁₅ register output.

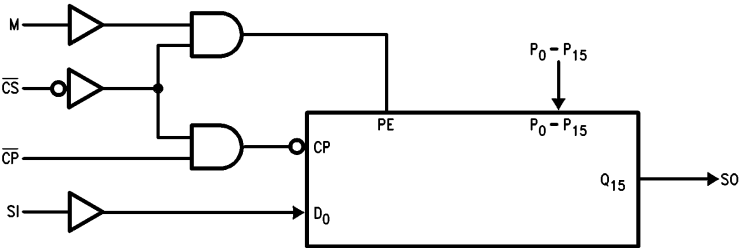
To prevent false clocking, $\overline{CP}$ must be LOW during a LOW-to-HIGH transition of $\overline{CS}$.

Shift Register Operations Table

Control Input			Operating Mode
$\overline{CS}$	M	$\overline{CP}$	
H	X	X	Hold
L	L	$\searrow$	Shift/Serial Load
L	H	$\searrow$	Parallel Load

H = HIGH Voltage Level
L = LOW Voltage Level
X = Immaterial
 $\searrow$ = HIGH-to-LOW Transition

Block Diagram



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Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Storage Temperature	−65°C to +150°C
Ambient Temperature under Bias	−55°C to +125°C
Junction Temperature under Bias	−55°C to +175°C
Plastic	−55°C to +150°C
V _{CC} Pin Potential to Ground Pin	−0.5V to +7.0V
Input Voltage (Note 2)	−0.5V to +7.0V
Input Current (Note 2)	−30 mA to +5.0 mA
Voltage Applied to Output in HIGH State (with V _{CC} = 0V)	
Standard Output	−0.5V to V _{CC}
TRI-STATE® Output	−0.5V to +5.5V
Current Applied to Output in LOW State (Max)	twice the rated I _{OL} (mA)

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

Recommended Operating Conditions

Free Air Ambient Temperature	
Military	−55°C to +125°C
Commercial	0°C to +70°C
Supply Voltage	
Military	+4.5V to +5.5V
Commercial	+4.5V to +5.5V

DC Electrical Characteristics

Symbol	Parameter	54F/74F			Units	V _{CC}	Conditions
		Min	Typ	Max			
V _{IH}	Input HIGH Voltage	2.0			V		Recognized as a HIGH Signal
V _{IL}	Input LOW Voltage			0.8	V		Recognized as a LOW Signal
V _{CD}	Input Clamp Diode Voltage			−1.2	V	Min	I _{IN} = −18 mA
V _{OH}	Output HIGH Voltage	54F 10% V _{CC} 74F 10% V _{CC} 74F 5% V _{CC}	2.5 2.5 2.7		V	Min	I _{OH} = −1 mA I _{OH} = −1 mA I _{OH} = −1 mA
V _{OL}	Output LOW Voltage	54F 10% V _{CC} 74F 10% V _{CC}		0.5 0.5	V	Min	I _{OL} = 20 mA I _{OL} = 20 mA
I _{IH}	Input HIGH Current	54F 74F		20.0 5.0	μA	Max	V _{IN} = 2.7V
I _{BVI}	Input HIGH Current Breakdown Test	54F 74F		100 7.0	μA	Max	V _{IN} = 7.0V
I _{CEX}	Output HIGH Leakage Current	54F 74F		250 50	μA	Max	V _{OUT} = V _{CC}
V _{ID}	Input Leakage Test	74F	4.75		V	0.0	I _{ID} = 1.9 μA, All Other Pins Grounded
I _{OD}	Output Leakage Circuit Current	74F		3.75	μA	0.0	V _{IOD} = 150 mV, All Other Pins Grounded
I _{IL}	Input LOW Current			−0.6	mA	Max	V _{IN} = 0.5V
I _{OS}	Output Short-Circuit Current		−60	−150	mA	Max	V _{OUT} = 0V
I _{CC}	Power Supply Current			72	mA	Max	

AC Electrical Characteristics

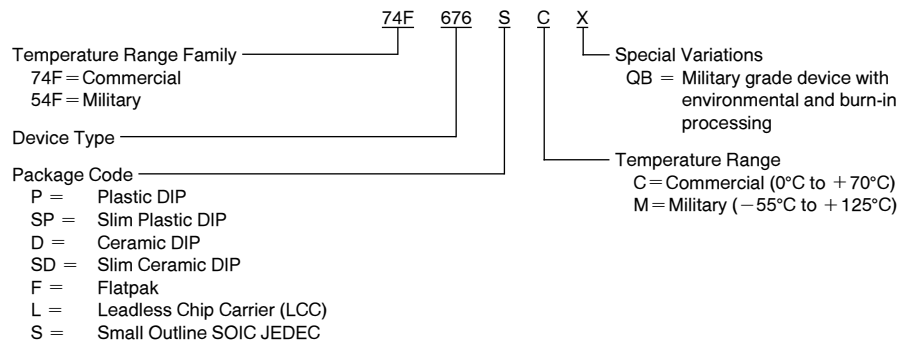
Symbol	Parameter	74F			54F		74F		Units
		T _A = + 25°C V _{CC} = + 5.0V C _L = 50 pF			T _A , V _{CC} = Mil C _L = 50 pF		T _A , V _{CC} = Com C _L = 50 pF		
		Min	Typ	Max	Min	Max	Min	Max	
f _{max}	Maximum Clock Frequency	100	110		45		90		MHz
t _{PLH}	Propagation Delay	4.5	9.0	11.0	4.5	17.0	4.5	12.0	ns
t _{PHL}	$\overline{\text{CP}}$ to SO	5.0	9.0	12.5	5.0	14.5	5.0	13.5	

AC Operating Requirements

Symbol	Parameter	74F		54F		74F		Units
		$T_A = +25^{\circ}\text{C}$ $V_{CC} = +5.0\text{V}$		$T_A, V_{CC} = \text{Mil}$		$T_A, V_{CC} = \text{Com}$		
		Min	Max	Min	Max	Min	Max	
$t_s(\text{H})$ $t_s(\text{L})$	Setup Time, HIGH or LOW SI to $\overline{\text{CP}}$	4.0 4.0		4.0 4.0		4.0 4.0		ns
$t_h(\text{H})$ $t_h(\text{L})$	Hold Time, HIGH or LOW SI to $\overline{\text{CP}}$	4.0 4.0		4.0 4.0		4.0 4.0		
$t_s(\text{H})$ $t_s(\text{L})$	Setup Time, HIGH or LOW P_n to $\overline{\text{CP}}$	3.0 3.0		3.0 3.0		3.0 3.0		ns
$t_h(\text{H})$ $t_h(\text{L})$	Hold Time, HIGH or LOW P_n to $\overline{\text{CP}}$	4.0 4.0		4.0 4.0		4.0 4.0		
$t_s(\text{H})$ $t_s(\text{L})$	Setup Time, HIGH or LOW M to $\overline{\text{CP}}$	8.0 8.0		8.0 8.0		8.0 8.0		ns
$t_h(\text{H})$ $t_h(\text{L})$	Hold Time, HIGH or LOW M to $\overline{\text{CP}}$	2.0 2.0		2.0 2.0		2.0 2.0		
$t_s(\text{L})$	Setup Time, LOW $\overline{\text{CS}}$ to $\overline{\text{CP}}$	10.0		12.0		10.0		ns
$t_h(\text{H})$	Hold Time, HIGH $\overline{\text{CS}}$ to $\overline{\text{CP}}$	10.0		10.0		10.0		
$t_w(\text{H})$ $t_w(\text{L})$	$\overline{\text{CP}}$ Pulse Width HIGH or LOW	4.0 6.0		5.0 9.0		4.0 6.0		ns

Ordering Information

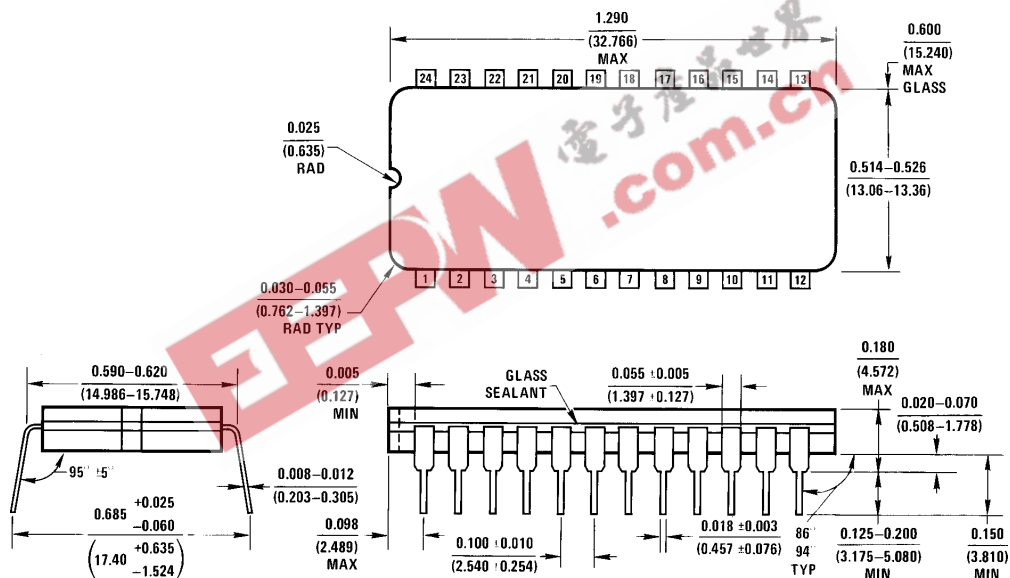
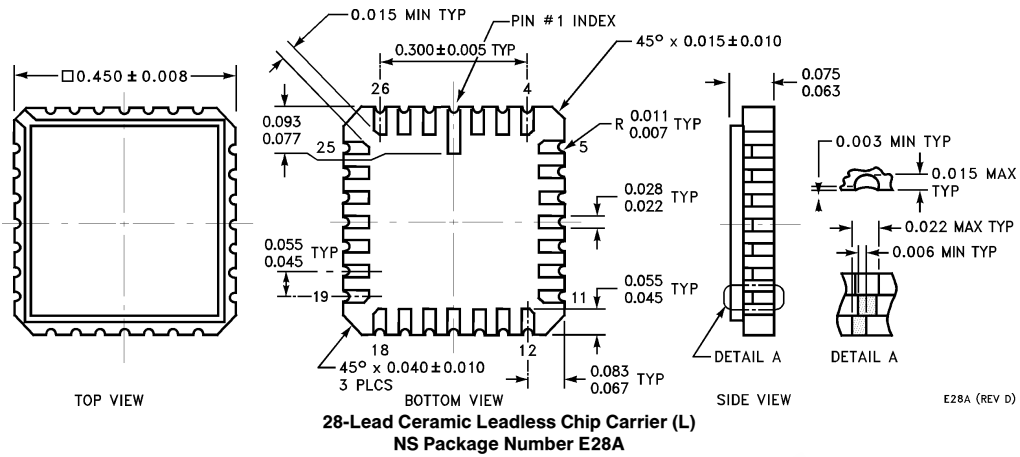
The device number is used to form part of a simplified purchasing code where the package type and temperature range are defined as follows:



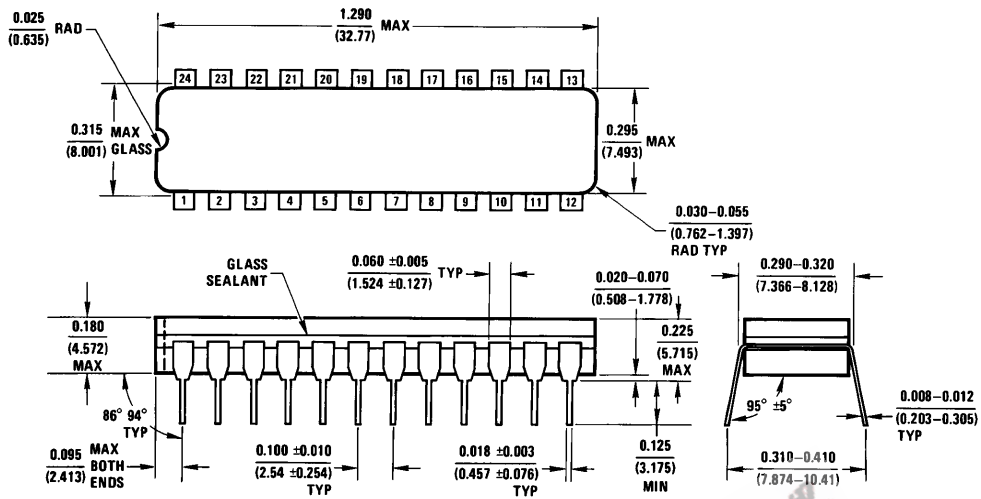
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Physical Dimensions inches (millimeters)

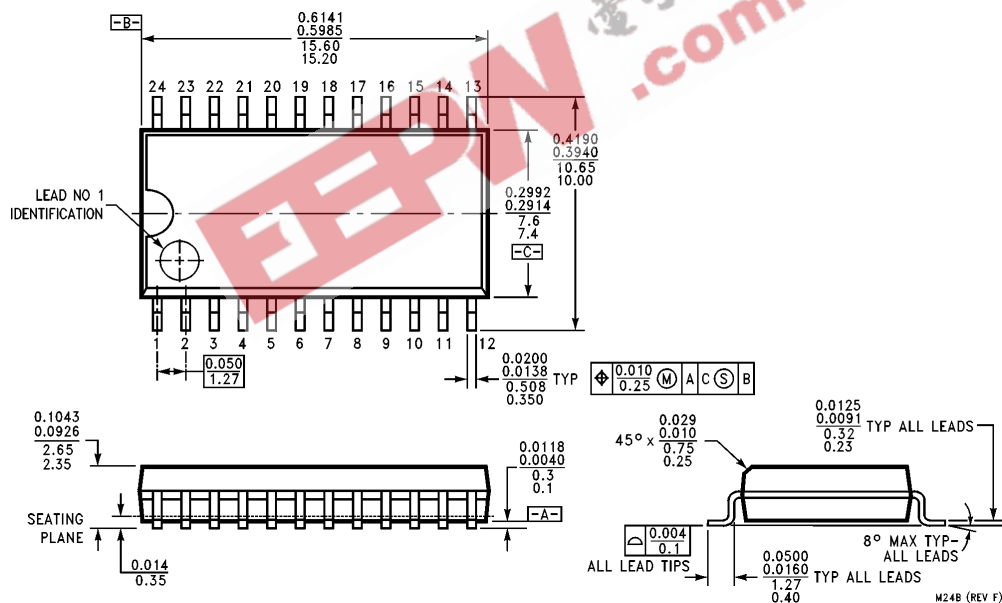


Physical Dimensions inches (millimeters) (Continued)



J24F (REV G)

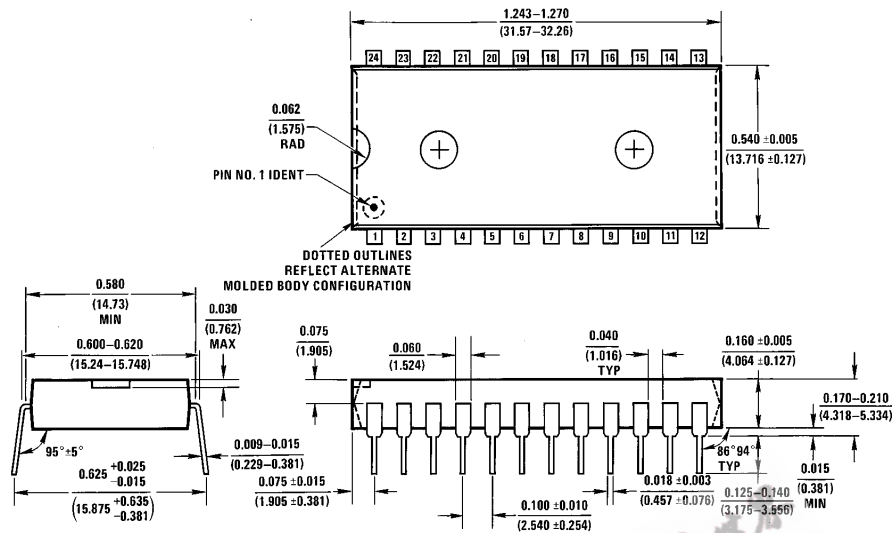
24-Lead (0.300" Wide) Ceramic Dual-In-Line Package (SD)
NS Package Number J24F



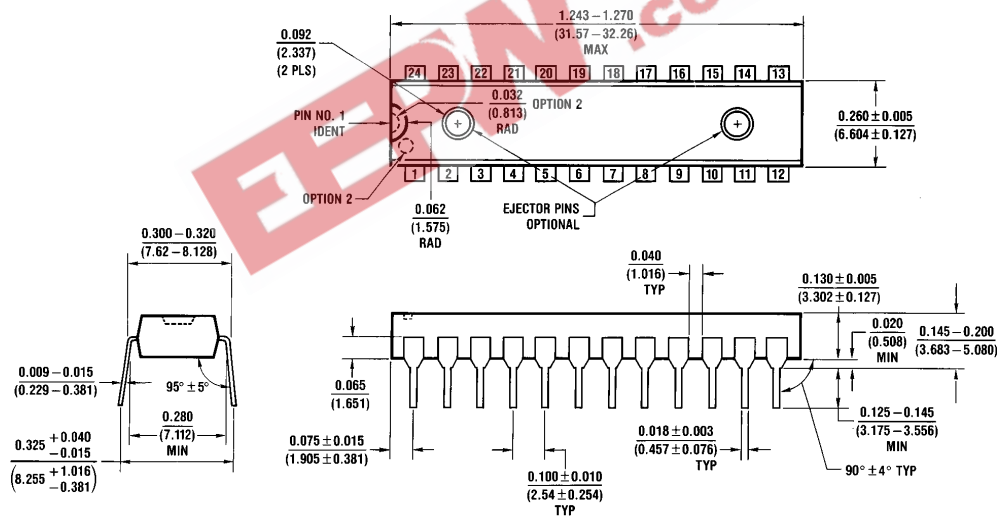
M24B (REV F)

24-Lead (0.300" Wide) Molded Small Outline Package, JEDEC
NS Package Number M24B

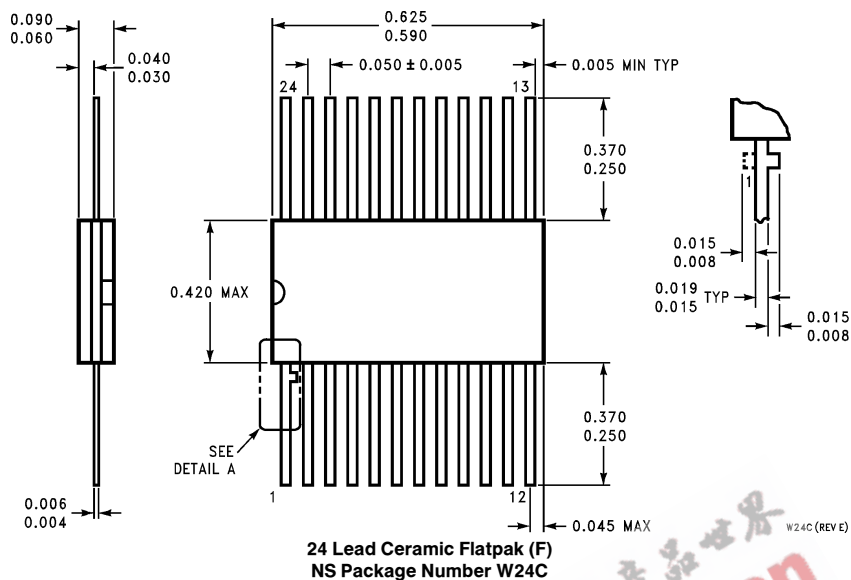
Physical Dimensions inches (millimeters) (Continued)



24-Lead (0.600" Wide) Molded Dual-In-Line Package (P)
NS Package Number N24A



24-Lead (0.300" Wide) Molded Dual-In-Line Package (SP)
NS Package Number N24C

Physical Dimensions inches (millimeters) (Continued)**LIFE SUPPORT POLICY**

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National Semiconductor Corporation
1111 West Bardin Road
Arlington, TX 76017
Tel: 1(800) 272-9959
Fax: 1(800) 737-7018

National Semiconductor Europe
Fax: (+49) 0-180-530 85 86
Email: cnjwge@levm2.nsc.com
Deutsch Tel: (+49) 0-180-530 85 85
English Tel: (+49) 0-180-532 78 32
Français Tel: (+49) 0-180-532 93 58
Italiano Tel: (+49) 0-180-534 16 80

National Semiconductor Hong Kong Ltd.
13th Floor, Straight Block,
Ocean Centre, 5 Canton Rd.
Tsimshatsui, Kowloon
Hong Kong
Tel: (852) 2737-1600
Fax: (852) 2736-9960

National Semiconductor Japan Ltd.
Tel: 81-043-299-2309
Fax: 81-043-299-2408